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SERIAL NUMBER 10/626,524	FILING OR 371(c) DATE 07/25/2003 RULE	CLASS 451	GROUP ART UNIT 3723	ATTORNEY DOCKET NO. ROH-0031/DIV
APPLICANTS Junichi Hikita, Kyoto, JAPAN; Ikuo Yoshida, Kyoto, JAPAN; Kazuhide Ino, Kyoto, JAPAN;				
** CONTINUING DATA ***** This application is a DIV of 09/704,563 11/03/2000 PAT 6,635,512 <i>Yes RR</i>				
** FOREIGN APPLICATIONS ***** JAPAN 11-314086 11/04/1999 JAPAN 11-314087 11/04/1999 JAPAN 11-314088 11/04/1999 <i>Yes RR</i>				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 04/21/2006				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after allowance Verified and Acknowledged <i>[Signature]</i> Examiner's Signature Initials		STATE OR COUNTRY JAPAN	SHEETS DRAWING 8	TOTAL CLAIMS 12
INDEPENDENT CLAIMS 1				
ADDRESS Mr. Steven M. Rabin c/o Rabin & Berdo, P.C. 1101 14th Street, NW Suite 500 Washington, DC20005				
TITLE Method of producing a semiconductor device by dividing a semiconductor wafer into separate pieces of semiconductor chips				
FILING FEE RECEIVED 750	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	